EMC Components

Chip beads For general signal line Low DC resistance type MMZ-H series



⊗TDK

MMZ1005-H type

FEATURES

- O Noise reduction solution for general signal line.
- This product is a low resistance than the standard "-C" series.
- It's possible to reduce power loss of a circuit.
- Operating temperature range: -55 to +125°C

APPLICATION

O Noise removal for mobile devices such as smartphones and tablet terminals, and various modules.

O Noise removal for PCs and recorders, household appliances such as STBs, smart grids, and industrial equipment.

PART NUMBER CONSTRUCTION

MMZ	1005	S	601	Н	Т	000
Series name	L×W×T dimensions 1.0×0.5x0.5 mm	Material name	Impedance (Ω) at 100MHz	Characteristic type	Packaging style	Internal code

CHARACTERISTICS SPECIFICATION TABLE

Impedance		DC resistance	Rated current	Part No.
[100MHz]				
(Ω)	Tolerance	(Ω)max .	(mA)max.	
80	±25%	0.10	800	MMZ1005S800HT000
120	±25%	0.13	700	MMZ1005S121HT000
240	±25%	0.18	600	MMZ1005S241HT000
600	±25%	0.34	440	MMZ1005S601HT000
1000	±25%	0.49	360	MMZ1005S102HT000

Measurement equipment

Measurement item	Product No.	Manufacturer		
Impedance	E4991A+16192A	Keysight Technologies		
DC resistance Type-7556		Yokogawa		

* Equivalent measurement equipment may be used.



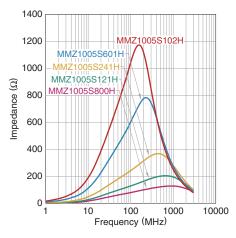
Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use.
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 Please note that the contents may change without any prior notice due to reasons such as upgrading.
 20190424



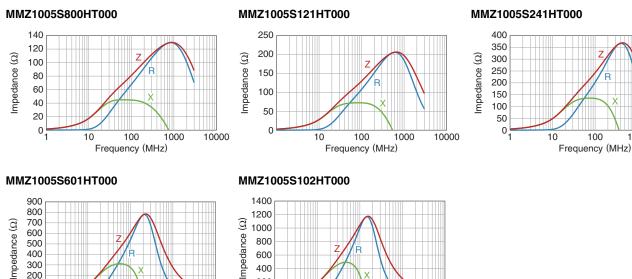
MMZ1005-H type

Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

MMZ1005S-H series



Z, X, R VS. FREQUENCY CHARACTERISTICS



200

0

10

100

Frequency (MHz)

1000

10000

公TDK

10000

1000

100

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100 0

10

100

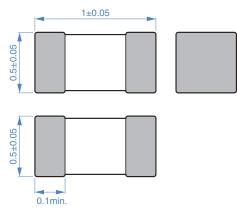
Frequency (MHz)

1000

10000

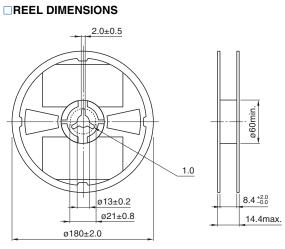
MMZ1005-H type

SHAPE & DIMENSIONS



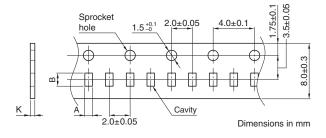
Dimensions in mm

PACKAGING STYLE

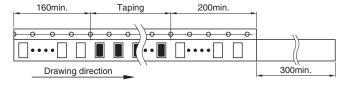


Dimensions in mm

TAPE DIMENSIONS



Туре	А	В	К
MMZ1005-H	0.65±0.1	1.15±0.1	0.8max.



Dimensions in mm

PACKAGE QUANTITY

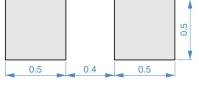
Package quantity 10,000 pcs/reel

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range	Storage temperature range*	Individual weight	
-55 to +125°C	1 mg		
The storage temperature range is for after the accomply			

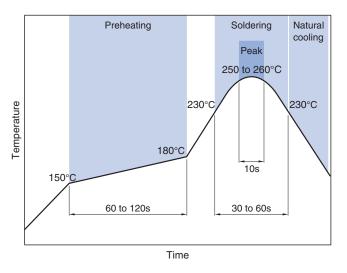
The storage temperature range is for after the assembly.

RECOMMENDED LAND PATTERN



Dimensions in mm

RECOMMENDED REFLOW PROFILE



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(3/4)
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REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

 The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH o less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. 				
Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).				
 Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature does not exceed 150°C. 	e difference between the solder temperature and chip temperature			
Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.				
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.				
 Self heating (temperature increase) occurs when the power is tur design. 	rned ON, so the tolerance should be sufficient for the set thermal			
 Carefully lay out the coil for the circuit board design of the non-mag A malfunction may occur due to magnetic interference. 	netic shield type.			
\bigcirc Use a wrist band to discharge static electricity in your body through	the grounding wire.			
○ Do not expose the products to magnets or magnetic fields.				
\bigcirc Do not use for a purpose outside of the contents regulated in the d	elivery specifications.			
ment, industrial robots) under a normal operation and use condition The products are not designed or warranted to meet the requirement ity require a more stringent level of safety or reliability, or whose fail person or property.	nent, personal equipment, office equipment, measurement equip-			
 (1) Aerospace/aviation equipment (2) Transportation equipment (cars, electric trains, ships, etc.) (3) Medical equipment (4) Power-generation control equipment (5) Atomic energy-related equipment (6) Seabed equipment (7) Transportation control equipment 	 (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment (12) Safety equipment (13) Other applications that are not considered general-purpose applications 			
When designing your equipment even for general-purpose application tection circuit/device or providing backup circuits in your equipment.	is, you are kindly requested to take into consideration securing pro-			

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